





THE INSTITUTE OF ELECTRICAL AND ELECTRONICS ENGINEERS

The Intersociety Conference on Thermal and Thermomechanical Phenomena in Electronic Systems

TOPOSINK

University of Utah

2021 IEEE EPS / ASME K-16 STUDENT HEAT SINK DESIGN CHALLENGE WINNER

Carter Cocke, Bence Csontos, Travis Allen, Erik Steenburgh, Michael Alverson, Hunter Scott

FOUNDED OF SHEET ON S

Dr. Justin A. Weibel General Chair, ITherm 2021 Dr. Dustin W. Demetriou Program Chair, ITherm 2021

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Dr. Satish Kumar Vice Program Chair, ITherm 2021

Satish Kumar